









LM317HV-MIL

JAJSDE2 – JUNE 2017

LM317HV-MIL 高電圧3端子、過負荷保護機能付きの可変レギュレータ

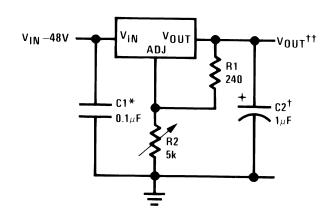
1 特長

- 最高60Vの入出力電圧差
- 1.5Aの出力電流
- ライン・レギュレーション0.01%/V (標準値)
- 負荷レギュレーション0.1% (標準値)
- 80dBのリップル除去(標準値)
- 内部的な短絡電流制限保護
- 過熱保護機能
- 0℃~125℃の動作温度範囲

2 アプリケーション

- 産業用電源
- PLCシステム
- ファクトリ・オートメーション・システム
- ビル・オートメーション・システム
- バッテリ充電器

高入力電圧の1.2V~50V可変レギュレータ



*デバイスがフィルタ・コンデンサから6インチ以上離れている場合に必要です。

†オプション - 過渡応答の改善

$$_{\dagger\dagger} V_{OUT} = 1.25 \ V \left(1 + \frac{R2}{R1} \right) + I_{ADJ} \left(R_2 \right)$$

3 概要

LM317HV-MILは可変の3端子正電圧レギュレータで、1.25V~57Vの出力電圧範囲で1.5A以上の電流を供給できます。出力電圧は、2つの外付け抵抗だけで設定できます。LM317HV-MILは標準のトランジスタ・パッケージで供給されているため、取り付けや取り扱いが簡単です。

LM317HV-MILには電流制限、熱過負荷保護、安全領域保護などの過負荷保護が搭載されているため、デバイスにブローアウト耐性があります。過負荷保護回路は、調整端子が接続されていない場合でも、常に完全な機能で動作します。

デバイスが入力フィルタ・コンデンサから6インチ以上離れていない限り、通常はコンデンサ不要です。6インチ以上離れている場合には、入力バイパス・コンデンサが必要です。過渡応答を改善するため、より大容量の出力コンデンサを追加することもできます。調整端子をバイパスして、非常に高いリップル除去率を実現することもできます。これは、標準的な3端子レギュレータでは実現困難です。

レギュレータはフローティング状態で、入力から出力への 差動電圧のみを受け取るため、入出力電圧差の最大値を 超過せず、出力からグランドへの短絡が発生しない限り、 数百ボルトの電圧の電源でもレギュレート可能です。

調整端子と出力の間に固定の抵抗を接続すると、 LM317HV-MILを高精度の電流レギュレータとしても使用できます。調整端子をグランドに固定すると、電子的なシャットダウン機能を持つ電源を作成でき、この場合は出力が1.25Vにプログラムされるため、ほとんどの負荷がわずかな電流しか消費しません。

製品情報(1)

型番	パッケージ	本体サイズ(公称)
	TO-39 (3)	8.255mm×8.255mm
LM317HV-MIL	TO-3 (2)	19.507mm×19.507mm
	TO-220 (3)	14.986mm×10.16mm

(1) 提供されているすべてのパッケージについては、巻末の注文情報を参照してください。





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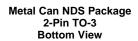
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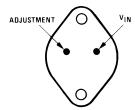
4 改訂履歴

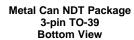
日付	改訂内容	注
2017年6月	*	初版

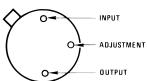


5 Pin Configuration and Functions

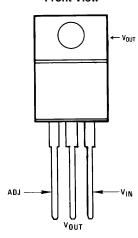












Pin Functions

		PIN									
NAME	TO-39 NO.	TO-3 NO.	TO-220 NO.	I/O	DESCRIPTION						
ADJ	2	1	1	_	Adjust Pin						
V _{OUT}	3, CASE	CASE	2, TAB	0	Output voltage pin for the regulator						
V _{IN}	1	2	3	I	Input voltage pin for the regulator						

TEXAS INSTRUMENTS

6 Specifications

6.1 Absolute Maximum Ratings

See (1).

	MIN	MAX	UNIT
Power dissipation	Internal	ly limited	
Input-output voltage differential	-0.3	60	V
Lead temperature (soldering, 10 seconds)		300	°C
Storage temperature, T _{stg}	-65	150	°C

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

			VALUE	UNIT
V _(ESD)	Electrostatic discharge	Human body model (HBM) ⁽¹⁾	±2000	V

⁽¹⁾ Manufacturing with less than 500-V HBM is possible with the necessary precautions.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

	MIN	MAX	UNIT
Operating junction temperature	0	125	°C

6.4 Thermal Information

	THERMAL METRIC ⁽¹⁾	NDT (TO-39)	NDS (TO-3)	NDE (TO-220)	UNIT
		3 PINS	2 PINS	3 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	140 ⁽²⁾	35 ⁽²⁾	23.0	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	12	2.3	15.9	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	_	_	4.6	°C/W
ΨЈТ	Junction-to-top characterization parameter	_	_	2.5	°C/W
ΨЈВ	Junction-to-board characterization parameter	_	_	4.6	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	_	_	0.9	°C/W

For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report, SPRA953.

⁽²⁾ No Heat Sink



6.5 Electrical Characteristics(1)

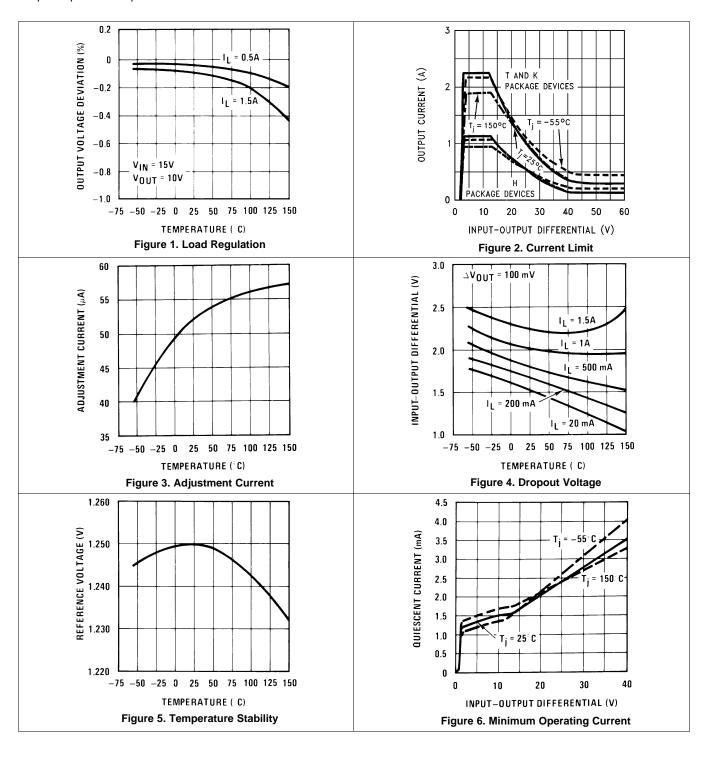
PARAMETER	TES	ST CONDITIONS	MIN	TYP	MAX	UNIT	
	21/21/ 1/ 20/	T _J = 25°C		0.01	0.04	%/V	
Line Regulation	$3 \text{ V} \le \text{V}_{\text{IN}} - \text{V}_{\text{OUT}} \le 60$ $\text{I}_{\text{L}} = 10 \text{ mA}^{(2)}$	over full Operating Temperature Range		0.02	0.07	%/V	
		$T_J = 25^{\circ}C$		0.1%	0.5%		
Load Regulation	10 mA ≤ I _{OUT} ≤ I _{MAX}	over full Operating Temperature Range		0.3%	1.5%		
Thermal Regulation	T _J = 25°C, 20 ms Pul	se		0.04	0.07	%/W	
Adjustment Pin Current				50	100	μА	
Adjustment Pin Current Change	10 mA \leq I _L \leq I _{MAX} 3 V \leq (V _{IN} - V _{OUT}) \leq	60 V		0.2	5	μΑ	
Reference Voltage	$3 \text{ V} \le (\text{V}_{\text{IN}} - \text{V}_{\text{OUT}}) \le$ $10 \text{ mA} \le \text{I}_{\text{OUT}} \le \text{I}_{\text{MAX}},$		1.2	1.25	1.3	V	
Temperature Stability	$T_{MIN} \le T_{J} \le T_{MAX}$			1%			
Minimum Load Current	$(V_{IN} - V_{OUT}) = 60 \text{ V}$			3.5	12	mA	
	(V _{IN} - V _{OUT}) ≤ 15	TO-3, TO-220 Packages	1.5	2.2	3.7	- A	
Command Lineit	V	TO-39 Package	0.5	0.8	1.9		
Current Limit	$(V_{IN} - V_{OUT}) \le 60$	TO-3, TO-220 Packages		0.3		۸	
	V	TO-39 Package		0.03		Α	
RMS Output Noise, % of V _{OUT}	T _J = 25°C, 10 Hz ≤ f	≤ 10 kHz		0.003%			
Pinnla Paiastian Patia	V _{OUT} = 10V, f = 120 l			65		dB	
Ripple Rejection Ratio	$C_{ADJ} = 10 \mu F$		66	80		dB	
Long-Term Stability	T _{.1} = 125°C			0.3%	1%		

⁽¹⁾ Unless otherwise specified, these specifications apply: 0°C ≤ T_J ≤ +125°C; V_{IN} − V_{OUT} = 5 V and I_{OUT} = 0.1 A for the TO-39 package and I_{OUT} = 0.5 A for the TO-3 and TO-220 packages. Although power dissipation is internally limited, these specifications are applicable for power dissipations of 2 W for the TO-39 and 20 W for the TO-3 and TO-220. I_{MAX} is 1.5 A for the TO-3 and TO-220 and 0.5 A for the TO-39 package.

⁽²⁾ Regulation is measured at constant junction temperature. Changes in output voltage due to heating effects must be taken into account separately. Pulse testing with low duty cycle is used.

6.6 Typical Characteristics

Output capacitor = $0 \mu F$ unless otherwise noted.

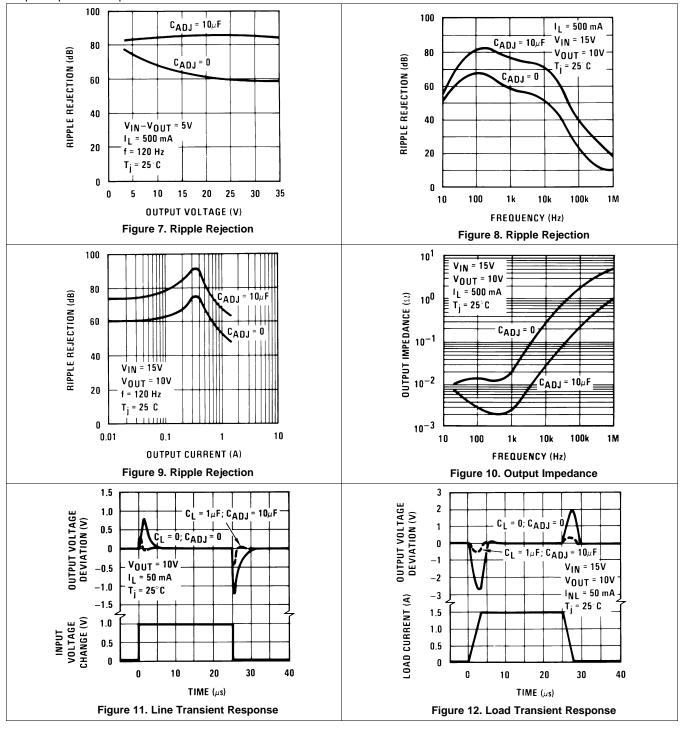




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Typical Characteristics (continued)

Output capacitor = $0 \mu F$ unless otherwise noted.



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7 Detailed Description

7.1 Overview

In operation, the LM317HV-MIL develops a nominal 1.25-V reference voltage, V_{REF} , between the output and adjustment terminal. The reference voltage is impressed across program resistor R1 and, since the voltage is constant, a constant current I_1 then flows through the output set resistor R2, giving an output voltage calculated by Equation 1:

$$V_{OUT} = V_{REF} \left(1 + \frac{R2}{R1} \right) + I_{ADJ} \left(R_2 \right)$$
(1)

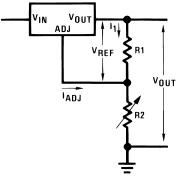
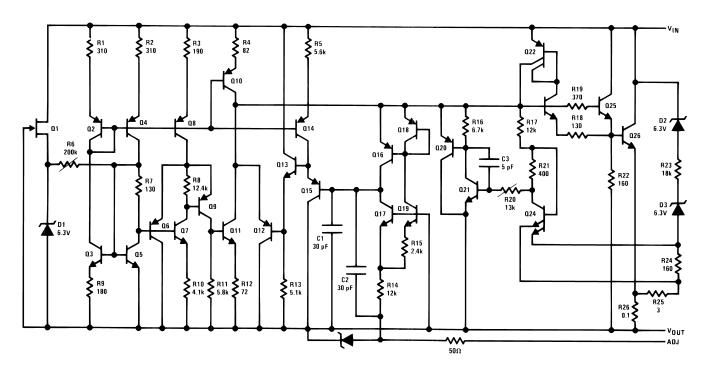


Figure 13. Adjustable V_{OUT} Through R1 and R2

Because the 100- μ A current from the adjustment terminal represents an error term, the LM317HV-MIL was designed to minimize I_{ADJ} and make it very constant with line and load changes. To do this, all quiescent operating current is returned to the output establishing a minimum load current requirement. If there is insufficient load on the output, the output will rise.

7.2 Functional Block Diagram



7.3 Feature Description

7.3.1 Load Regulation

The LM317HV-MIL is capable of providing extremely good load regulation but a few precautions are needed to obtain maximum performance. The current set resistor, R1, should be connected near the output terminal of the regulator rather than near the load. If R1 is placed too far from the output terminal, then the increased trace resistance, R_S, will cause an error voltage drop in the adjustment loop and degrade load regulation performance. Therefore, R1 should be placed as close as possible to the output terminal to minimize R_S and maximize load regulation performance.

Figure 14 shows the effect of the trace resistance, R_S, when R1 is placed far from the output terminal of the regulator. It is clear that R_S will cause an error voltage drop especially during higher current loads, so it is important to minimize the R_S trace resistance by keeping R1 close to the regulator output terminal.

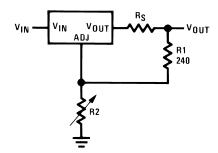


Figure 14. Regulator With Line Resistance in Output Lead

With the TO-3 package, it is easy to minimize the resistance from the case to the set resistor, by using two separate leads to the case. However, with the TO-39 package, take care to minimize the wire length of the output lead. The ground of R2 can be returned near the ground of the load to provide remote ground sensing and improve load regulation.

7.3.2 Current Limit

Internal current limit will be activated whenever the output current exceeds the limit indicated in Typical Characteristics. However, if the regulators differential voltage exceeds the absolute maximum rating of 60 V during a short-circuit condition (for example: V_{IN} ≥ 60 V, V_{OUT} = 0 V), internal junctions in the regulator may break down and the device may be damaged or fail. Failure modes range from an apparent open or short from input to output of the regulator, to a destroyed package (most common with the TO-220 package). To protect the regulator, the user is advised to be aware of voltages that may be applied to the regulator during fault conditions and to avoid violating the Absolute Maximum Ratings.

7.4 Device Functional Modes

7.4.1 External Capacitors

An input bypass capacitor is recommended. A 0.1-μF disc or 1-μF solid tantalum on the input is suitable input bypassing for almost all applications. The device is more sensitive to the absence of input bypassing when adjustment or output capacitors are used but the above values will eliminate the possibility of problems.

The adjustment terminal can be bypassed to ground on the LM317HV-MIL to improve ripple rejection. This bypass capacitor prevents ripple from being amplified as the output voltage is increased. With a 10-μF bypass capacitor the 80-dB ripple rejection is obtainable at any output level. Increases over 10 µF do not appreciably improve the ripple rejection at frequencies above 120 Hz. If the bypass capacitor is used, it is sometimes necessary to include protection diodes to prevent the capacitor from discharging through internal low current paths and damaging the device.

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Device Functional Modes (continued)

In general, the best type of capacitors to use are solid tantalum. Solid tantalum capacitors have low impedance even at high frequencies. Depending upon capacitor construction, it takes about 25 μF in aluminum electrolytic to equal 1 μF of solid tantalum at high frequencies. Ceramic capacitors are also good at high frequencies, but some types have a large decrease in capacitance at frequencies around 0.5 MHz. For this reason, a 0.01- μF disc may seem to work better than a 0.1- μF disc as a bypass.

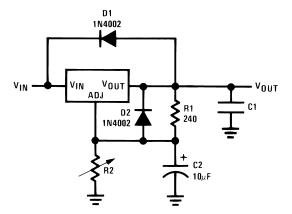
Although the LM317HV-MIL is stable with no output capacitors, like any feedback circuit, certain values of external capacitance can cause excessive ringing. This occurs with values between 500 pF and 5000 pF. A 1- μ F solid tantalum (or 25- μ F aluminum electrolytic) on the output swamps this effect and ensures stability. Any increase of load capacitance larger than 10 μ F will merely improve the loop stability and output impedance.

7.4.2 Protection Diodes

When external capacitors are used with any IC regulator it is sometimes necessary to add protection diodes to prevent the capacitors from discharging through low current points into the regulator. Most 10-µF capacitors have low enough internal series resistance to deliver 20-A spikes when shorted. Although the surge is short, there is enough energy to damage parts of the IC.

When an output capacitor is connected to a regulator and the input is shorted, the output capacitor will discharge into the output of the regulator. The discharge current depends on the value of the capacitor, the output voltage of the regulator, and the rate of decrease of VIN. In the LM317HV-MIL, this discharge path is through a large junction that is able to sustain 15-A surge with no problem. This is not true of other types of positive regulators. For output capacitors of 25 μ F or less, there is no need to use diodes.

The bypass capacitor on the adjustment terminal can discharge through a low current junction. Discharge occurs when either the input or output is shorted. Internal to the LM317HV-MIL is a $50-\Omega$ resistor which limits the peak discharge current. No protection is needed for output voltages of 25 V or less and $10-\mu$ F capacitance. Figure 15 shows an LM317HV-MIL with protection diodes included for use with outputs greater than 25 V and high values of output capacitance.



$$V_{OUT} = 1.25 \text{ V} \left(1 + \frac{R2}{R1} \right) + I_{ADJ} (R_2)$$

D1 protects against C1

D2 protects against C2

Figure 15. Regulator With Protection Diodes



8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

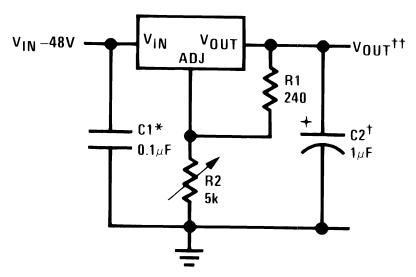
8.1 Application Information

The LM317HV-MIL is a high voltage input capable linear regulator with overload protection. Due to its wide input voltage range, the LM317HV-MIL serves a variety of applications and provides a precise voltage regulation with low dropout across a wide output voltage and load current range. The device regulates a constant 1.25 V between V_{OUT} and ADJ, so placing a fixed resistor between these pins provides a constant current regulation. Capacitors at the input help filter the input power supply, while the output capacitors aid in transient response stability. A bypass capacitor can be placed between ADJ pin and ground (across R2) to improve ripple rejection.

8.2 Typical Applications

8.2.1 1.25-V to 45-V High Voltage Adjustable Regulator

The device can be used as an adjustable regulator to allow a variety of output voltages for high voltage applications. By using an adjustable R2 resistor, a variety of output voltages can be made possible as shown in Figure 16.



Full output current not available at high input-output voltages

†Optional—improves transient response. Output capacitors in the range of 1 μ F to 1000 μ F of aluminum or tantalum electrolytic

are commonly used to provide improved output impedance and rejection of transients.

*Needed if device is more than 6 inches from filter capacitors.

$$V_{OUT} = 1.25 V \left(1 + \frac{R2}{R1} \right) + I_{ADJ} (R_2)$$

Figure 16. 1.25-V to 45-V High Voltage Adjustable Regulator

8.2.1.1 Design Requirements

The device component count is very minimal, employing two resistors as part of a voltage divider circuit and an output capacitor for load regulation. An input capacitor is needed if the device is more than 6 inches from filter capacitors. An optional bypass capacitor across R2 can also be used to improve PSRR.

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Typical Applications (continued)

8.2.1.2 Detailed Design Procedure

The output voltage is set based on the selection of the two resistors, R1 and R2, as shown in Figure 16. For details on capacitor selection, refer to *External Capacitors*.

8.2.1.3 Application Curve

As shown in Figure 17, the maximum output current capability is limited by the input-output voltage differential, package type, and junction temperature.

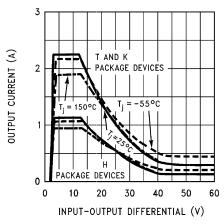


Figure 17. Current Limit

8.2.2 Digitally Selected Outputs

Figure 18 shows a digitally selectable output voltage. In its default state, all transistors are off and the output voltage is set based on R1 and R2. By driving certain transistors, the associated resistor is connected in parallel to R2, modifying the output voltage of the regulator.

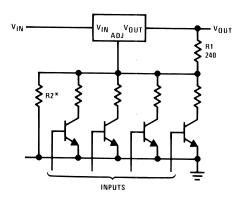


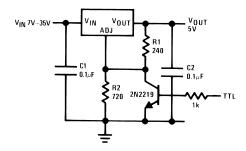
Figure 18. Digitally Selected Outputs

8.2.3 Logic Regulator (5-V) With Electronic Shutdown

A variation of the 5-V output regulator application uses the LM317HV-MIL along with an NPN transistor to provide shutdown control. The NPN will either block or sink the current from the ADJ pin by responding to the TTL pin logic. When TTL is pulled high, the NPN is on and pulls the ADJ pin to GND, and the device outputs about 1.25 V. When TTL is pulled low, the NPN is off and the regulator outputs according to the programmed adjustable voltage.

^{*}Sets maximum V_{OUT}





NOTE: *Min. output ≈ 1.2 V

Figure 19. Logic Regulator (5-V) With Electronic Shutdown

8.2.4 Slow Turnon 15-V Regulator

An application of LM317HV-MIL includes a PNP transistor with a capacitor to implement slow turnon functionality. As V_{IN} rises, the PNP sinks current from the ADJ rail. The output voltage at start-up is the addition of the 1.25-V reference plus the drop across the base to emitter. While this is happening, the capacitor begins to charge and eventually opens the PNP. At this point, the device functions normally, regulating the output at 15 V. A diode is placed between C1 and V_{OUT} to provide a path for the capacitor to discharge. Such controlled turnon is useful for limiting the in-rush current.

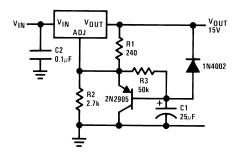
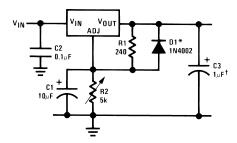


Figure 20. Slow Turnon 15-V Regulator

8.2.5 Adjustable Regulator With Improved Ripple Rejection

To improve ripple rejection, a capacitor is used to bypass the ADJ pin to GND. This is used to smooth output ripple by cleaning the feedback path and stopping unnecessary noise from being fed back into the device, propagating the noise.



†Solid tantalum

Figure 21. Adjustable Regulator With Improved Ripple Rejection

^{*}Discharges C1 if output is shorted to ground

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8.2.6 High Stability 10-V Regulator

Using a high-stability shunt voltage reference in the feedback path, such as the LM329, provides damping necessary for a stable, low noise output.

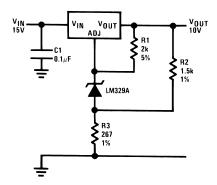
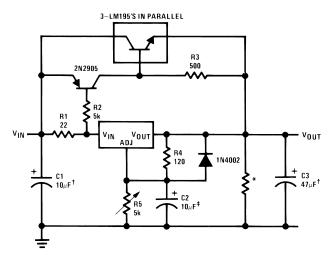


Figure 22. High Stability 10-V Regulator

8.2.7 High Current Adjustable Regulator

Using the LM195 power transistor in parallel with the LM317HV-MIL can increase the maximum possible output load current. Sense resistor R1 provides the 0.6 V across base to emitter to turn on the PNP. This on switch allows current to flow, and the voltage drop across R3 drives three LM195 power transistors designed to carry an excess of 1 A each. Note the selection of R1 determines a minimum load current for the PNP to turn on. The higher the resistor value, the lower the load current must be before the transistors turn on.



- †Solid tantalum
- *Minimum load current = 30 mA
- ‡Optional—improves ripple rejection

Figure 23. High Current Adjustable Regulator

8.2.8 Emitter Follower Current Amplifier

The device is used as a constant current source in this emitter follower circuit. The LM195 power transistor is being used as a current gain amplifier, boosting the INPUT current. The device provides a stable current bias than just using a resistor.



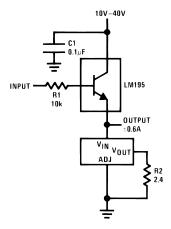


Figure 24. Emitter Follower Current Amplifier

8.2.9 1-A Current Regulator

A simple, fixed-current regulator can be made by placing a resistor between the V_{OUT} and ADJ pins of the LM317HV-MIL. By regulating a constant 1.25 V between these two terminals, a constant current is delivered to the load.

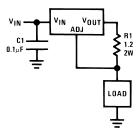


Figure 25. 1-A Current Regulator

8.2.10 Common Emitter Amplifier

Sometimes it is necessary to use a power transistor for high current gain. In this case, the LM317HV-MIL provides constant current at the collector of the LM195 in this common emitter application. The 1.25-V reference between V_{OUT} and ADJ is maintained across the 2.4- Ω resistor, providing about 500-mA constant bias current into the collector of the LM195.

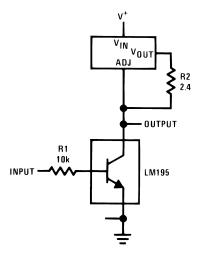
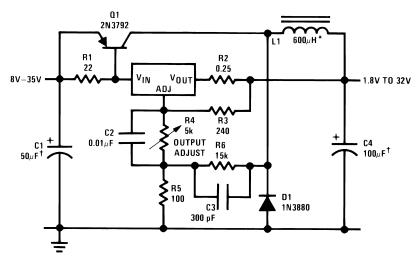


Figure 26. Common Emitter Amplifier

TEXAS INSTRUMENTS

8.2.11 Low-Cost, 3-A Switching Regulator

The LM317HV-MIL can be used in a switching buck regulator application in cost-sensitive applications that require high efficiency. The switch node above D1 oscillates between ground and VIN, as the voltage across sense resistor R1 drives the power transistor on and off. This circuit exhibits self-oscillating behavior by negative feedback through R6 and C3 to the ADJ pin of the LM317HV-MIL.



†Solid tantalum

*Core-Arnold A-254168-2 60 turns

Figure 27. Low-Cost, 3-A Switching Regulator

8.2.12 Adjustable Multiple On-Card Regulators With Single Control

This application shows how multiple LM317HV-MIL regulators can be controlled by setting one resistor. Because each device maintains the reference voltage of about 1.25 V between its V_{OUT} and ADJ pins, we can connect each ADJ rail to a single resistor, setting the same output voltage across all devices. This allows for independent outputs, each responding to its corresponding input only. Designers must also consider that by the nature of the circuit, changes to R1 and R2 affect all regulators.

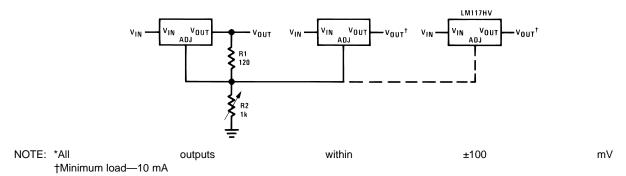


Figure 28. Adjustable Multiple On-Card Regulators With Single Control



8.2.13 AC Voltage Regulator

In Figure 29, the top regulator is +6 V above the bottom regulator. It is clear that when the input rises above +6 V plus the dropout voltage, only the top LM317HV-MIL regulates +6 V at the output. When the input falls below –6 V minus the dropout voltage, only the bottom LM317HV-MIL regulates –6 V at the output. For regions where the output is not clipped, there is no regulation taking place, so we see the output follow the input.

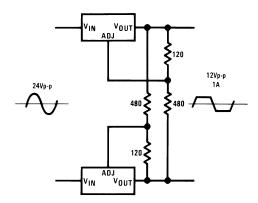
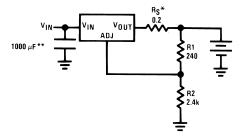


Figure 29. AC Voltage Regulator

8.2.14 12-V Battery Charger

The LM317HV-MIL can be used in a battery charger application, where the device maintains either constant voltage or constant current mode depending on the current charge of the battery. To do this, the part senses the voltage drop across the battery and delivers the maximum charging current necessary to charge the battery. When the battery charge is low, there exists a voltage drop across the sense resistor R_S, providing constant current to the battery at that instant. As the battery approaches full charge, the potential drop across R_S approaches zero, reducing the current and maintaining the fixed voltage of the battery.



$$R_S$$
 – sets output impedance of charger $Z_{OUT} = R_S \left(1 + \frac{R^2}{R^4} \right)$

Use of R_S allows low charging rates with fully charged battery. **The 1000 μF is recommended to filter out input transients

Figure 30. 12-V Battery Charger

TEXAS INSTRUMENTS

8.2.15 Adjustable 4-A Regulator

Using three LM317HV-MIL devices in parallel increases load current capability. Output voltage is set by the variable resistor tied to the non-inverting terminal of the op amp, and reference current to the transistor is developed across the $100-\Omega$ resistor. When output voltage rises, the op amp corrects by drawing current from the base, closing the transistor. This effectively pulls ADJ down and lowers the output voltage through negative feedback.

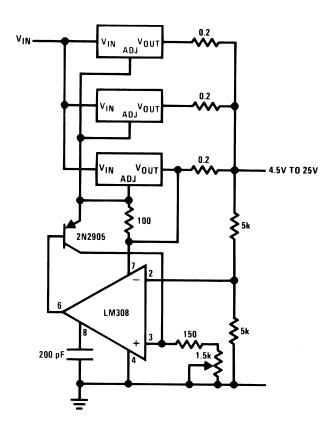


Figure 31. Adjustable 4-A Regulator

8.2.16 Current Limited 6-V Charger

The current in a battery charger application is limited by switching between constant current and constant voltage states. When the battery pulls low current, the drop across the 1- Ω resistor is not substantial and the NPN remains off. A constant voltage is seen across the battery, as regulated by the resistor divider. When current through the battery rises past peak current, the 1 Ω provides enough voltage to turn the transistor on, pulling ADJ close to ground. This results in limiting the maximum current to the battery.



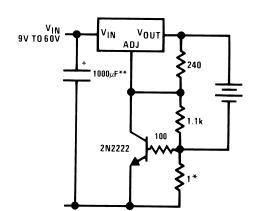


Figure 32. Current Limited 6-V Charger

^{*}Sets peak current (0.6 A for 1 $\Omega)$ **The 1000 μF is recommended to filter out input transients



9 Power Supply Recommendations

Normally, no capacitors are needed unless the device is situated more than six inches from the input filter capacitors, in which case an input bypass is needed. An optional output capacitor can be added to improve transient response. The adjustment terminal can be bypassed to achieve very high ripple rejections ratios, which are difficult to achieve with standard 3-terminal regulators. For information regarding capacitor selection, refer to *External Capacitors*.

10 Layout

10.1 Layout Guidelines

Some layout guidelines should be followed to ensure proper regulation of the output voltage with minimum noise. Traces carrying the load current should be wide to reduce the amount of parasitic trace inductance and the feedback loop from V_2 to ADJ should be kept as short as possible. To improve PSRR, a bypass capacitor can be placed at the ADJ pin and should be located as close as possible to the IC. In cases when VIN shorts to ground, an external diode should be placed from V_{OUT} to VIN to divert the surge current from the output capacitor and protect the IC. Similarly, in cases when a large bypass capacitor is placed at the ADJ pin and V_{OUT} shorts to ground, an external diode should be placed from ADJ to V_{OUT} to provide a path for the bypass capacitor to discharge. These diodes should be placed close to the corresponding IC pins to increase their effectiveness.

10.2 Layout Example

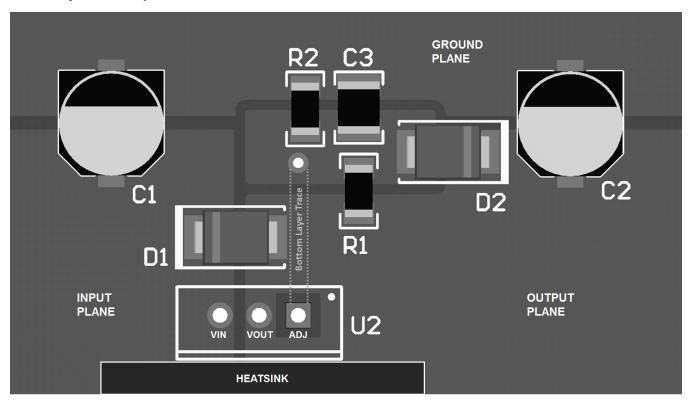


Figure 33. Layout Example (TO-220 Package)

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11 デバイスおよびドキュメントのサポート

11.1 関連リンク

次の表に、クイック・アクセス・リンクを示します。カテゴリには、技術資料、サポートおよびコミュニティ・リソース、ツールとソフトウェア、およびサンプル注文またはご購入へのクイック・アクセスが含まれます。

表 1. 関連リンク

製品	プロダクト・フォルダ	サンプルとご購入	技術資料	ツールとソフトウェア	サポートとコミュニティ
LM317HV-MIL	ここをクリック	ここをクリック	ここをクリック	ここをクリック	ここをクリック

11.2 コミュニティ・リソース

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11.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

12 メカニカル、パッケージ、および注文情報

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10-Dec-2020

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
LM317HVH	ACTIVE	ТО	NDT	3	500	RoHS & Green	AU	Level-1-NA-UNLIM	0 to 0	(LM317HVHP+, LM31 7HVHP+)	Samples
LM317HVH/NOPB	ACTIVE	ТО	NDT	3	500	RoHS & Green	AU	Level-1-NA-UNLIM	0 to 0	(LM317HVHP+, LM31 7HVHP+)	Samples
LM317HVK STEEL	ACTIVE	TO-3	NDS	2	50	Non-RoHS & Non-Green	Call TI	Call TI	0 to 0	LM317HVK STEELP+	Samples
LM317HVK STEEL/NOPB	ACTIVE	TO-3	NDS	2	50	RoHS & Green	Call TI	Level-1-NA-UNLIM	0 to 0	LM317HVK STEELP+	Samples

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ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

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- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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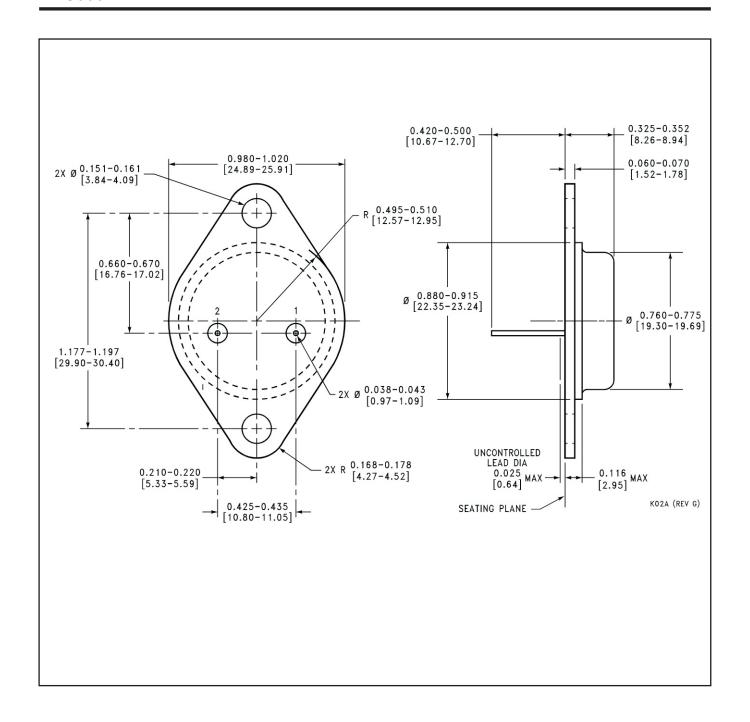


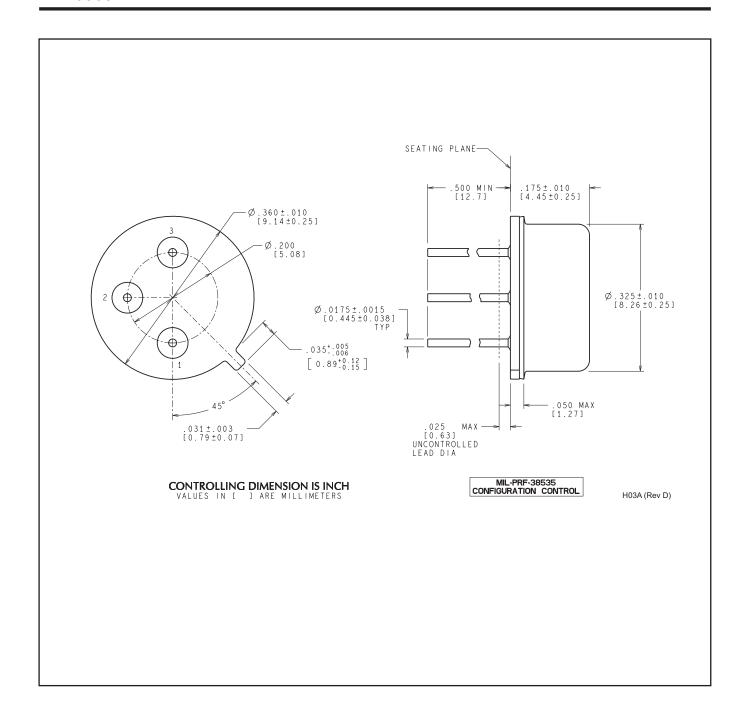
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